

UC1637 UC2637 UC3637

Switched Mode Controller for DC Motor Drive

FEATURES

- Single or Dual Supply Operation
- ±2.5V to ±20V Input Supply Range
- ±5% Initial Oscillator Accuracy; ± 10% Over Temperature
- Pulse-by-Pulse Current Limiting
- Under-Voltage Lockout
- Shutdown Input with Temperature Compensated 2.5V Threshold
- Uncommitted PWM Comparators for Design Flexibility
- Dual 100mA, Source/Sink Output Drivers

DESCRIPTION

The UC1637 is a pulse width modulator circuit intended to be used for a variety of PWM motor drive and amplifier applications requiring either uni-directional or bi-directional drive circuits. When used to replace conventional drivers, this circuit can increase efficiency and reduce component costs for many applications. All necessary circuitry is included to generate an analog error signal and modulate two bi-directional pulse train outputs in proportion to the error signal magnitude and polarity.

This monolithic device contains a sawtooth oscillator, error amplifier, and two PWM comparators with ± 100 mA output stages as standard features. Protection circuitry includes under-voltage lockout, pulse-by-pulse current limiting, and a shutdown port with a 2.5V temperature compensated threshold.

The UC1637 is characterized for operation over the full military temperature range of -55°C to +125°C, while the UC2637 and UC3637 are characterized for -25°C to +85°C and 0°C to +70°C, respectively.

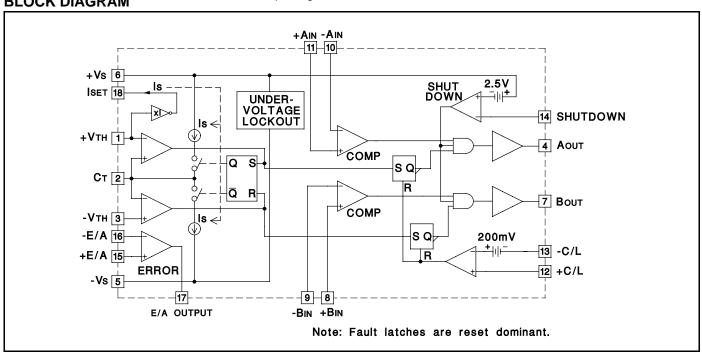
ABSOLUTE MAXIMUM RATINGS (Note 1)

Supply Voltage (±Vs)	±20V
Output Current, Source/Sink (Pins 4, 7)	500mA
Analog Inputs (Pins 1, 2, 3, 8, 9, 10, 11 12, 13, 14, 15, 16)	±Vs
Error Amplifier Output Current (Pin 17)	±20mA
Oscillator Charging Current (Pin 18)	2mA
Power Dissipation at TA = 25°C (Note 2)	1000mW
Power Dissipation at Tc = 25°C (Note 2)	2000mW
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10 Seconds)	+300°C

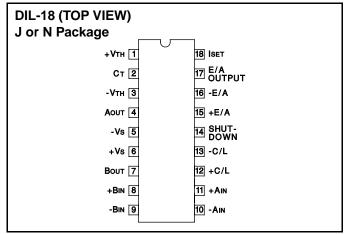
Note 1: Currents are positive into, negative out of the specified terminal.

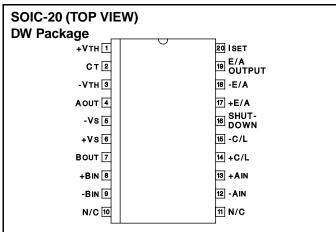
Note 2: Consult Packaging Section of Databook for thermal limitations and considerations of package.

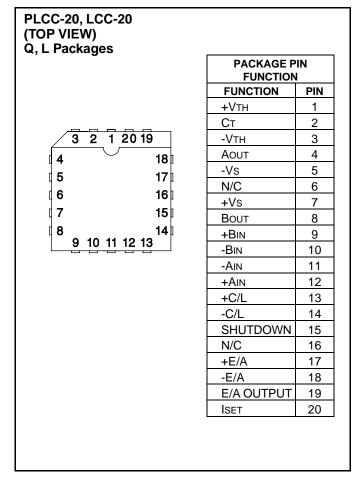
BLOCK DIAGRAM



CONNECTION DIAGRAM







ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for TA = -55°C to +125°C for the UC1637; -25°C to +85°C for the UC2637; and 0°C to +70°C for the UC3637; +Vs = +15V, -Vs = -15V, +VTH = 5V, -VTH = -5V, RT = 16.7k Ω , CT = 1500pF, TA=TJ.

PARAMETER	TEST CONDITIONS	UC1	637/UC	2637		UNITS		
		MIN	TYP	MAX	MIN	TYP	MAX	
Oscillator								
Initial Accuracy	T _J = 25°C (Note 6)	9.4	10	10.6	9	10	11	kHz
Voltage Stability	$Vs = \pm 5V \text{ to } \pm 20V, VPIN 1 = 3V, VPIN 3 = -3V$		5	7		5	7	%
Temperature Stability	Over Operating Range (Note 3)		0.5	2		0.5	2	%
+Vтн Input Bias Current	VPIN 2 = 6V	-10	0.1	10	-10	0.1	10	μΑ
-Vтн Input Bias Current	VPIN 2 = 0V	-10	-0.5		-10	-0.5		μΑ
+Vтн, -Vтн Input Range		+Vs-2		-Vs+2	+Vs-2		-Vs+2	V
Error Amplifier								
Input Offset Voltage	Vcm = 0V		1.5	5		1.5	10	mV
Input Bias Current	VCM = 0V		0.5	5		0.5	5	μΑ
Input Offset Current	VCM = 0V		0.1	1		0.1	1	μΑ
Common Mode Range	Vs = ±2.5 to 20V	-Vs+2		+Vs	-Vs+2		+Vs	V
Open Loop Voltage Gain	RL = 10k	75	100		80	100		dB
Slew Rate			15			15		V/µs
Unity Gain Bandwidth			2			2		MHz
CMRR	Over Common Mode Range	75	100		75	100		dB
PSRR	$Vs = \pm 2.5 \text{ to } \pm 20V$	75	110		75	110		dB

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for TA = -55°C to +125°C for the UC1637; -25°C to +85°C for the UC2637; and 0°C to +70°C for the UC3637: Vs = +15V, -Vs = -15V, +VTH = 5V, -VTH = -5V, RT = 16.7k Ω , CT = 1500pF, TA=TJ.

PARAMETERS	TEST CONDITIONS	UC1	637/UC	2637		•	UNITS	
		MIN	TYP	MAX	MIN	TYP	MAX	
Error Amplifier (Continued)								
Output Sink Current	VPIN 17 = 0V		-50	-20		-50	-20	mA
Output Source Current	VPIN 17 = 0V	5	11		5	11		mA
High Level Output Voltage		13	13.6		13	13.6		V
Low Level Output Voltage			-14.8	-13		-14.8	-13	V
PWM Comparators								
Input Offset Voltage	Vcm = 0V		20			20		mV
Input Bias Current	Vcm = 0V		2	10		2	10	μΑ
Input Hysteresis	Vcm = 0V		10			10		mV
Common Mode range	$Vs = \pm 5V \text{ to } \pm 20V$	-Vs+1		+Vs-2	-Vs+1		+Vs-2	V
Current Limit								
Input Offset Voltage	Vcm = 0V, T _J = 25°C	190	200	210	180	200	220	mV
Input Offset Voltage T.C.			-0.2			-0.2		mV/°C
Input Bias Current		-10	-1.5		-10	-1.5		μΑ
Common Mode Range	$Vs = \pm 2.5V \text{ to } \pm 20V$	-Vs		+Vs-3	-Vs		+Vs-3	V
Shutdown								
Shutdown Threshold	(Note 4)	-2.3	-2.5	-2.7	-2.3	-2.5	-2.7	V
Hysteresis			40			40		mV
Input Bias Current	VPIN 14 = +VS to -VS	-10	-0.5		-10	-0.5		μΑ
Under-Voltage Lockout								
Start Threshold	(Note 5)		4.15	5.0		4.15	5.0	V
Hysteresis			0.25			0.25		mV
Total Standby Current								
Supply Current			8.5	15		8.5	15	mA
Output Section								
Output Low Level	ISINK = 20mA		-14.9	-13		-14.9	-13	V
	ISINK = 100mA		-14.5	-13		-14.5	-13	
Output High Level	ISOURCE = 20mA	13	13.5		13	13.5		V
	ISOURCE = 100mA	12	13.5		12	13.5		
Rise Time	(Note 3) CL = Inf, TJ = 25°C		100	600		100	600	ns
Fall Time	(Note 3) CL = Inf, TJ = 25°C		100	300		100	300	ns

- Note 3: These parameters, although guaranteed over the recommended operating conditions, are not 100% tested in production.
- Note 4: Parameter measured with respect to +Vs (Pin 6).
- Note 5: Parameter measured at +Vs (Pin 6) with respect to -Vs (Pin 5).
- Note 6: RT and CT referenced to Ground.

FUNCTIONAL DESCRIPTION

Following is a description of each of the functional blocks shown in the Block Diagram.

Oscillator

The oscillator consists of two comparators, a charging and discharging current source, a current source set terminal, ISET and a flip-flop. The upper and lower threshold of the oscillator waveform is set externally by applying a voltage at pins +VTH and -VTH respectively. The +VTH ter-

minal voltage is buffered internally and also applied to the ISET terminal to develop the capacitor charging current through RT. If RT is referenced to -Vs as shown in Figure 1, both the threshold voltage and charging current will vary proportionally to the supply differential, and the oscillator frequency will remain constant. The triangle waveform oscillators frequency and voltage amplitude is determined by the external components using the formulas given in Figure 1.

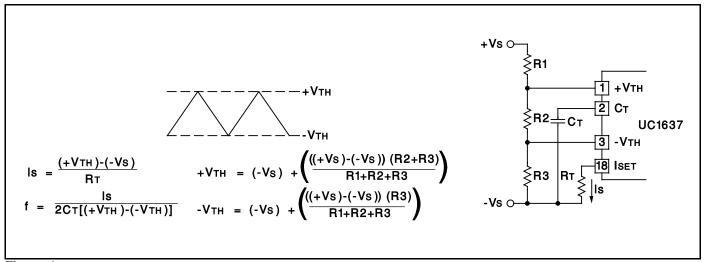


Figure 1. Oscillator Setup

PWM Comparators

Two comparators are provided to perform pulse width modulation for each of the output drivers. Inputs are uncommitted to allow maximum flexibility. The pulse width of the outputs A and B is a function of the sign and amplitude of the error signal. A negative signal at Pin 10 and 8 will lengthen the high state of output A and shorten the high state of output B. Likewise, a positive error signal reverses the procedure. Typically, the oscillator waveform is compared against the summation of the error signal and the level set on Pin 9 and 11.

MODULATION SCHEMES

Case A Zero Deadtime (Equal voltage on Pin 9 and Pin 11) In this configuration, maximum holding torque or stiffness and position accuracy is achieved. However, the power input into the motor is increased. Figure 3A shows this configuration.

Case B Small Deadtime (Voltage on Pin 9 > Pin 11)

A small differential voltage between Pin 9 and 11 provides the necessary time delay to reduce the chances of momentary short circuit in the output stage during transitions, especially where power-amplifiers are used. Refer to Figure 3B.

Case C Increased Deadtime and Deadband Mode (Voltage on Pin 9 > Pin 11)

With the reduction of stiffness and position accuracy, the power input into the motor around the null point of the servo loop can be reduced or eliminated by widening the window of the comparator circuit to a degree of acceptance. Where position accuracy and mechanical stiffness is unimportant, deadband operation can be used. This is shown in Figure 3C.

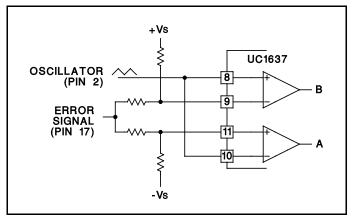


Figure 2. Comparator Biasing

Output Drivers

Each output driver is capable of both sourcing and sinking 100mA steady state and up to 500mA on a pulsed basis for rapid switching of either POWERFET or bipolar transistors. Output levels are typically -Vs + 0.2V @50mA low level and +Vs - 2.0V @50mA high level.

Error Amplifier

The error amplifier consists of a high slew rate $(15V/\mu s)$ op-amp with a typical 1MHz bandwidth and low output impedance. Depending on the $\pm Vs$ supply voltage, the common mode input range and the voltage output swing is within 2V of the Vs supply.

Under-Voltage Lockout

An under-voltage lockout circuit holds the outputs in the low state until a minimum of 4V is reached. At this point, all internal circuitry is functional and the output drivers are enabled. If external circuitry requires a higher starting voltage, an over-riding voltage can be programmed through the shutdown terminal as shown in Figure 4.

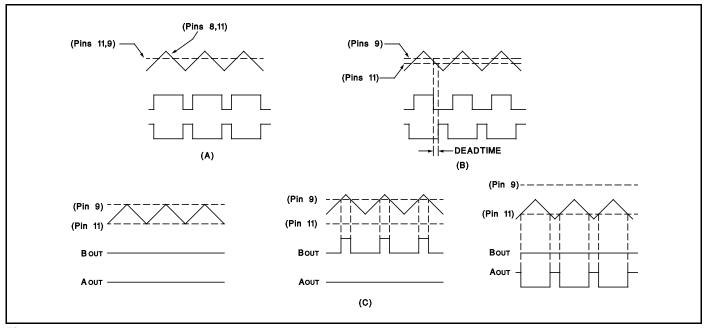


Figure 3. Modulation Schemes Showing (A) Zero Deadtime (B) Deadtime and (C) Deadband Configurations

Shutdown Comparator

The shutdown terminal may be used for implementing various shutdown and protection schemes. By pulling the terminal more than 2.5V below VIN, the output drivers will be enabled. This can be realized using an open collector gate or NPN transistor biased to either ground or the negative supply. Since the threshold is temperature stabilized, the comparator can be used as an accurate low voltage lockout (Figure 4) and/or delayed start as in Figure 5. In the shutdown mode the outputs are held in the low state.

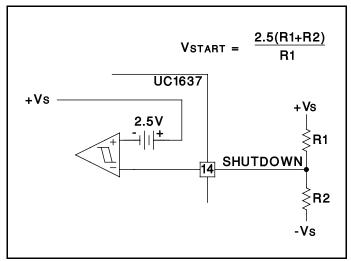


Figure 4. External Under-Voltage Lockout

Current Limit

A latched current limit amplifier with an internal 200mV offset is provided to allow pulse-by-pulse current limiting. Differential inputs will accept common mode signals from

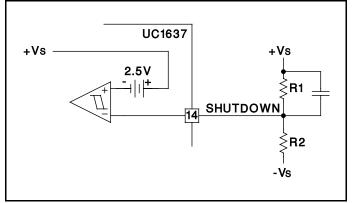


Figure 5. Delayed Start-Up

-Vs to within 3V of the +Vs supply while providing excellent noise rejection. Figure 6 shows a typical current sense circuit.

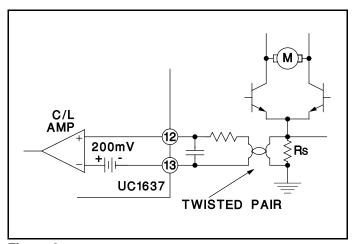


Figure 6. Current Limit Sensing

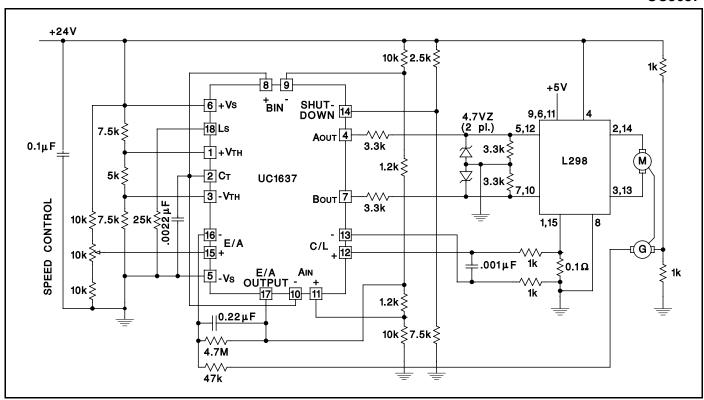


Figure 7. Bi-Directional Motor Drive with Speed Control Power-Amplifier

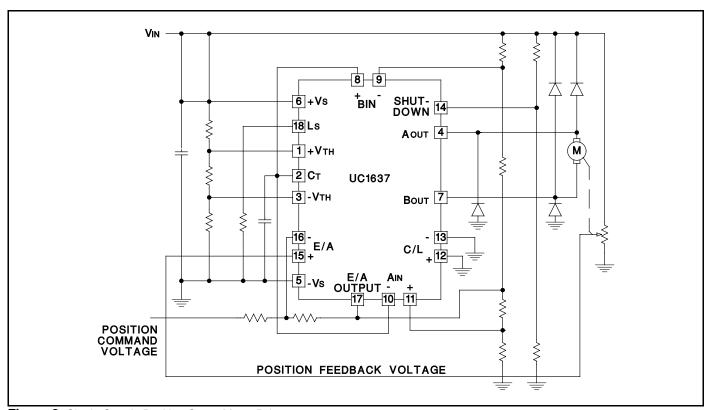


Figure 8. Single Supply Position Servo Motor Drive

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
5962-89957012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 89957012A UC1637L/ 883B
5962-8995701VA	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8995701VA UC1637J/883B
UC1637J	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1637J
UC1637J.A	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1637J
UC1637J883B	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8995701VA UC1637J/883B
UC1637J883B.A	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-8995701VA UC1637J/883B
UC1637L	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1637L
UC1637L.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	UC1637L
UC1637L883B	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 89957012A UC1637L/ 883B
UC1637L883B.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962- 89957012A UC1637L/ 883B
UC2637DW	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2637DW
UC2637DW.A	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2637DW
UC2637DWG4	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2637DW
UC2637DWTR	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2637DW
UC2637DWTR.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-25 to 85	UC2637DW
UC2637J	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	0 to 0	UC2637J
UC2637J.A	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	0 to 0	UC2637J
UC2637N	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-25 to 85	UC2637N
UC2637N.A	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-25 to 85	UC2637N
UC2637NG4	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	-25 to 85	UC2637N



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Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
UC3637DW	Active	Production	SOIC (DW) 20	25 TUBE	Yes	(4) NIPDAU	(5) Level-2-260C-1 YEAR	0 to 70	UC3637DW
UC3637DW.A	Active	Production	SOIC (DW) 20	25 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3637DW
UC3637DWTR	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3637DW
UC3637DWTR.A	Active	Production	SOIC (DW) 20	2000 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UC3637DW
UC3637J	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	0 to 70	UC3637J
UC3637J.A	Active	Production	CDIP (J) 18	20 TUBE	No	SNPB	N/A for Pkg Type	0 to 70	UC3637J
UC3637N	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3637N
UC3637N.A	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3637N
UC3637NG4	Active	Production	PDIP (N) 18	20 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	UC3637N

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE OPTION ADDENDUM

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF UC1637, UC3637, UC3637M:

Catalog: UC3637, UC3637M, UC3637

• Military : UC1637, UC1637

• Space : UC1637-SP

NOTE: Qualified Version Definitions:

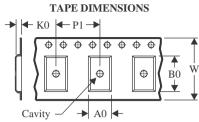
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UC2637DWTR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
UC3637DWTR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1

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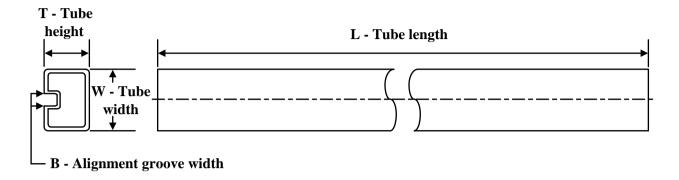
*All dimensions are nominal

Device	Package Type	Package Type Package Drawing		SPQ	Length (mm)	Width (mm)	Height (mm)	
UC2637DWTR	SOIC	DW	20	2000	367.0	367.0	45.0	
UC3637DWTR	SOIC	DW	20	2000	367.0	367.0	45.0	



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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-89957012A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1637L	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1637L.A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1637L883B	FK	LCCC	20	55	506.98	12.06	2030	NA
UC1637L883B.A	FK	LCCC	20	55	506.98	12.06	2030	NA
UC2637DW	DW	SOIC	20	25	507	12.83	5080	6.6
UC2637DW.A	DW	SOIC	20	25	507	12.83	5080	6.6
UC2637DWG4	DW	SOIC	20	25	507	12.83	5080	6.6
UC2637N	N	PDIP	18	20	506	13.97	11230	4.32
UC2637N.A	N	PDIP	18	20	506	13.97	11230	4.32
UC2637NG4	N	PDIP	18	20	506	13.97	11230	4.32
UC3637DW	DW	SOIC	20	25	507	12.83	5080	6.6
UC3637DW.A	DW	SOIC	20	25	507	12.83	5080	6.6
UC3637N	N	PDIP	18	20	506	13.97	11230	4.32
UC3637N.A	N	PDIP	18	20	506	13.97	11230	4.32
UC3637NG4	N	PDIP	18	20	506	13.97	11230	4.32

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



INSTRUMENTS www.ti.com

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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